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Low resistance measurements – Methods and guidance

Mesures de faibles résistances – Méthodes et recommandations

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LOW RESISTANCE MEASUREMENTS – METHODS AND GUIDANCE

FOREWORD

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International Standard IEC 62812 has been prepared by IEC technical committee 40: Capacitors and resistors for electronic equipment.

The text of this International Standard is based on the following documents:

FDIS	Report on voting
40/2665/FDIS	40/2671/RVD

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
- amended.

The contents of the corrigendum of March 2020 have been included in this copy.

LOW RESISTANCE MEASUREMENTS – METHODS AND GUIDANCE

1 Scope

Resistance measurements are typically compromised by a variety of phenomena, for example serial resistance in the measurement path, self-heating or non-ohmic properties. Whether the effect of such phenomena on a resistance measurement is acceptable or not depends on the magnitude of each effect in comparison to the resistance and to the required accuracy. Hence, the risk of erroneous resistance measurements increases with decreasing resistance and with a tightening of the permissible tolerance.

This document specifies methods of measurement and associated test conditions that eliminate or reduce the influence of adverse phenomena in order to improve the attainable accuracy of low-resistance measurements.

The methods described in this document are applicable for the individual measurements of the resistance of individual resistors, and also for resistance measurements as part of a test sequence. They are applied if prescribed by a relevant component specification, or if agreed between a customer and a manufacturer.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 60068-1, *Environmental testing - Part 1: General and guidance*

IEC 60115-1:2008, *Fixed resistors for use in electronic equipment – Part 1: Generic specification*

IEC 60294, *Measurement of the dimensions of a cylindrical component with axial terminations*

3 Terms and definitions

For the purposes of this document, the terms and definitions given in IEC 60115-1 and the following apply.

A list of used letter symbols and abbreviated terms is provided in Annex A.

ISO and IEC maintain terminological databases for use in standardization at the following addresses:

- IEC Electropedia: available at http://www.electropedia.org/
- ISO Online browsing platform: available at http://www.iso.org/obp

3.1
electromotive force
e.m.f.
difference in potential that gives rise to an electric current